

## I . SCOPE :

This specification applies to the Pb Free high current type SMD Common mode filter  
for MCM-1211AM-SERIES-□□

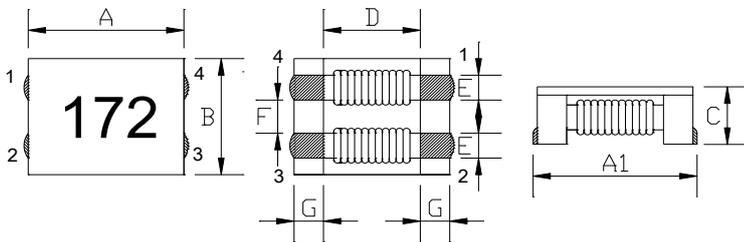
### PRODUCT IDENTIFICATION

MCM - 1211AM - 172 - □□

①      ②      ③      ④

- ① Product Code
- ② Dimensions Code
- ③ Impedance Code
- ④ Inner Control Code

## (1) SHAPES AND DIMENSIONS



A:	12.0±0.5	mm
A1:	12.5±0.5	mm
B:	10.8±0.5	mm
C:	8.5 Max.	mm
D:	7.0 Typ.	mm
E:	2.7±0.2	mm
F:	2.5±0.2	mm
G:	2.5±0.2	mm

## (2) ELECTRICAL SPECIFICATIONS

### SEE TABLE 1

#### TEST INSTRUMENTS

- Z : HP 4291B IMPEDANCE ANALYZER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHM METER (or equivalent)
- I.R : CHROMA MODEL 19073 AC/DC/IR HIPOT TESTER (or equivalent)

## (3) CHARACTERISTICS

- (3)-1 Operate temperature range ..... -40°C ~ +125°C  
(Including self temp. rise)
- (3)-2 Storage temperature range ..... -40°C ~ +125°C



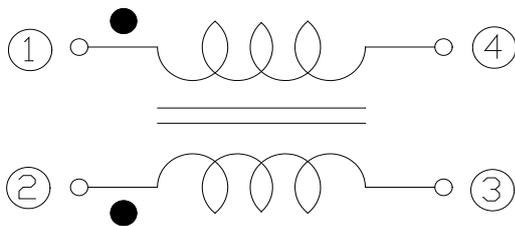
MAG.LAYERS

**TABLE 1**

MAGLAYERS PT/NO.	Impedance( $\Omega$ ) at 2.52MHz		Resistance RDC( $\Omega$ ) Max.(1 line)	Rated Current (A) Max.	Insulation Resistance (M $\Omega$ ) Min.	Rated Voltage (V)Max.	Marking
	Min.	Typ.					
MCM-1211AM-172-□□	1100	1700	26m	5.5	10	125	172
MCM-1211AM-202-□□	1300	2000	33m	4.5	10	125	202
MCM-1211AM-222-□□	1400	2200	43m	4.0	10	125	222
MCM-1211AM-532-□□	3700	5300	109m	2.5	10	125	532
MCM-1211AM-782-□□	5400	7800	182m	2.0	10	125	782

Rated Current : Based on temperature rise ( $\Delta T$  : 40°C TYP.)

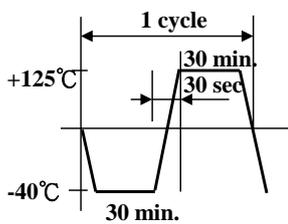
**CHARACTERISTICS(REFERENCE)**



**(4) RELIABILITY TEST METHOD**  
**MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Solder ability	The product shall be connected to the test circuit board by the fillet (the height is 0.2mm).	Apply cream solder to the printed circuit board . Refer to clause 8 for Reflow profile.
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	<p>Temperature profile of reflow soldering</p> <p>The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.</p>
Terminal strength	The terminal electrode and the ferrite must not damaged.	<p>Solder a chip to test substrate , and then laterally apply a load 9.8N in the arrow direction.</p>
Strength on PC board bending	The terminal electrode and the ferrite must not damaged.	<p>Solder a chip to test substrate and then apply a load.</p> <p>Test board:FR4 100×40×1mm Fall speed:1mm/sec. Dimensions in mm</p>
High temperature resistance	<p>Impedance:Within±20% of the initial value.</p> <p>Insulation resistance and DC resistance on the specification(refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not damaged.</p>	<p>After the samples shall be soldered onto the test circuit board,the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : +125±2°C</p> <p>Applied voltage : Rated voltage</p> <p>Applied current : Rated current</p> <p>Testing time : 500±12 hours</p>

**(4) RELIABILITY TEST METHOD**  
**MECHANICAL**

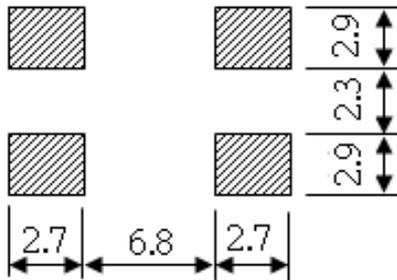
TEST ITEM	SPECIFICATION	TEST DETAILS
Humidity resistance	<p>Impedance: Within <math>\pm 20\%</math> of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : <math>+60 \pm 2^\circ\text{C}</math> , Humidity : 90 to 95 %RH</p> <p>Applied voltage : Rated voltage</p> <p>Applied current : Rated current</p> <p>Testing time : <math>500 \pm 12</math> hours</p>
Thermal shock	<p>Impedance: Within <math>\pm 20\%</math> of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	
Low temperature storage	<p>Impedance: Within <math>\pm 20\%</math> of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Measurement : After placing for 24 hours min.</p> <p>Temperature : <math>-40 \pm 2^\circ\text{C}</math></p> <p>Testing time : <math>500 \pm 12</math> hours</p>
Vibration	<p>Impedance: Within <math>\pm 20\%</math> of the initial value.</p> <p>Insulation resistance and DC resistance on the specification (refer to clause 2-1) shall be met.</p> <p>The terminal electrode and the ferrite must not be damaged.</p>	<p>After the samples shall be soldered onto the test circuit board, the test shall be done.</p> <p>Frequency : 10 to 55 Hz</p> <p>Amplitude : 1.52 mm</p> <p>Dimension and times : X , Y and Z directions for 2 hours each.</p>
Solderability	<p>New solder More than 75%</p>	<p>Flux (rosin, isopropyl alcohol {JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of <math>130 \sim 150^\circ\text{C}</math> and after it has been immersed to a depth 0.5mm below for <math>3 \pm 0.2</math> seconds fully in molten solder M705 with a temperature of <math>245 \pm 5^\circ\text{C}</math>. More than 75% of the electrode sections shall be covered with new solder smoothly when the sample is taken out of the solder bath.</p>

## (5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

### (5)-1 LAND PATTERN DIMENSIONS

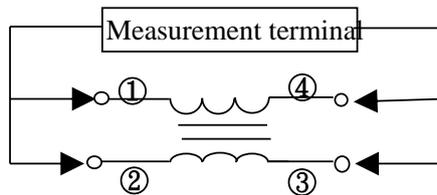
(STANDARD PATTERN) Unit:mm



## (6) TEST EQUIPMENT

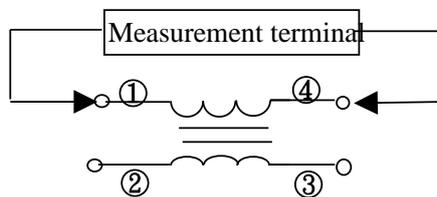
### (6)-1 Impedance

Measured by using HP4291B RF Impedance Analyzer.



### (6)-2 DC Resistance

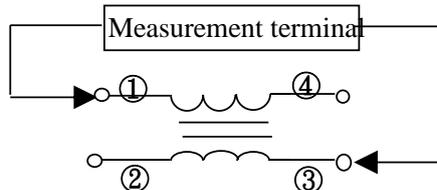
Measured by using Chroma 16502 milliohm meter.



### (6)-3 Insulation Resistance

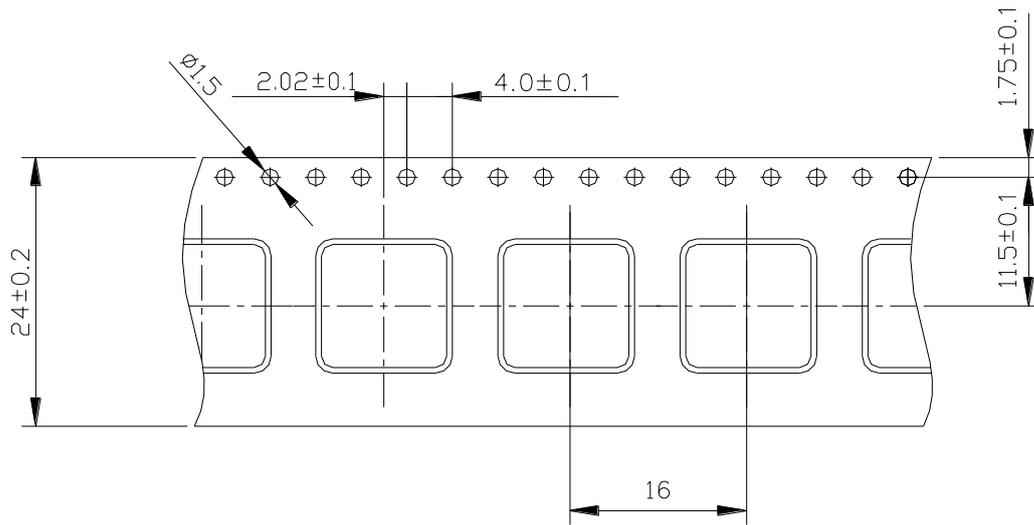
Measured by using Chroma 19073

Measurement voltage : 50v , Measurement time : 60 sec.

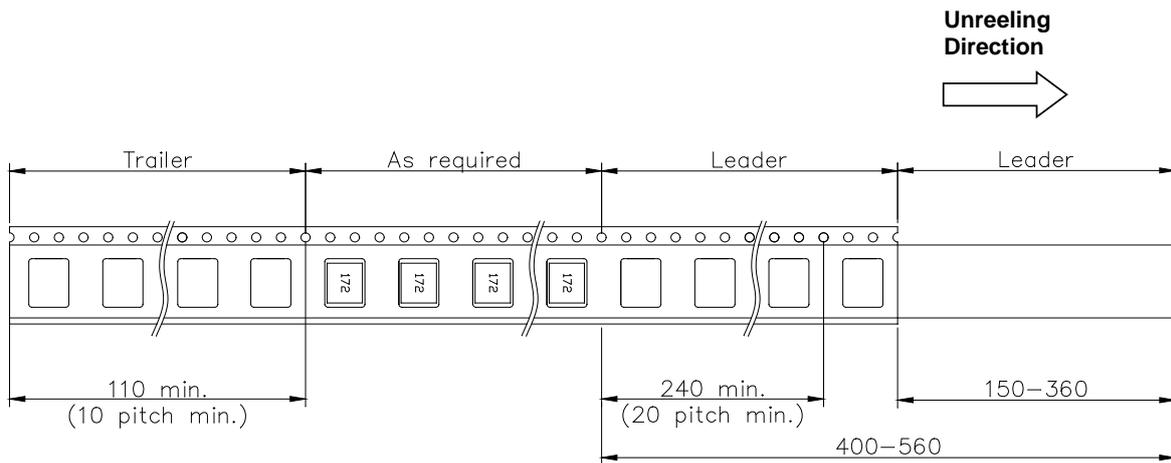


## (6) PACKAGING

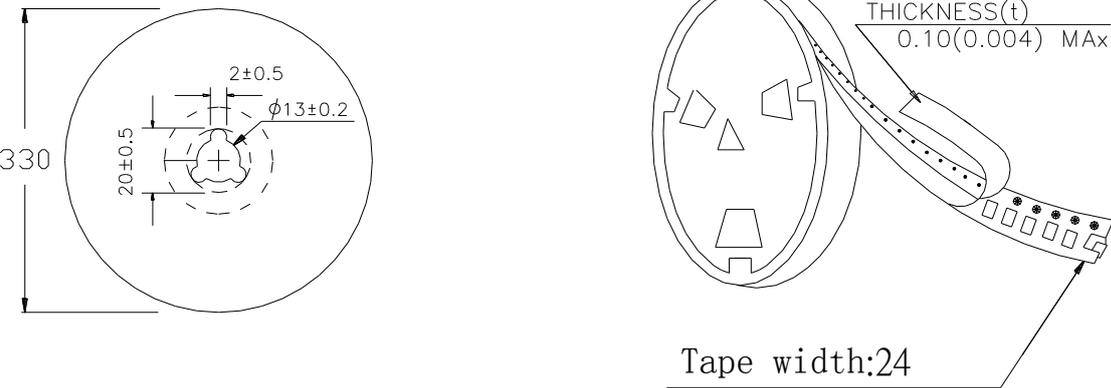
### (6)-1 CARRIER TAPE DIMENSIONS (mm)



### (6)-2 TAPING DIMENSIONS (mm)



**(6)-3 REEL DIMENSIONS (mm)**



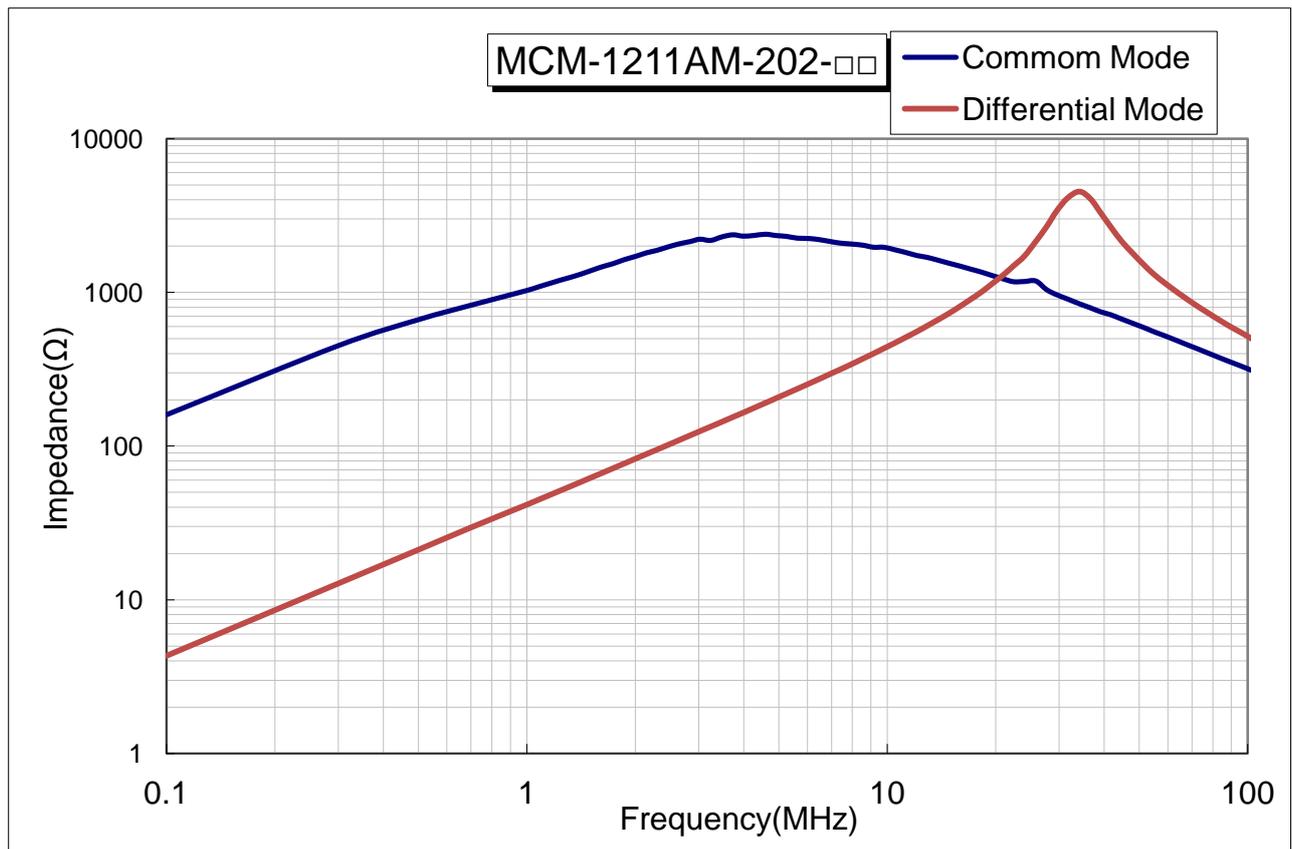
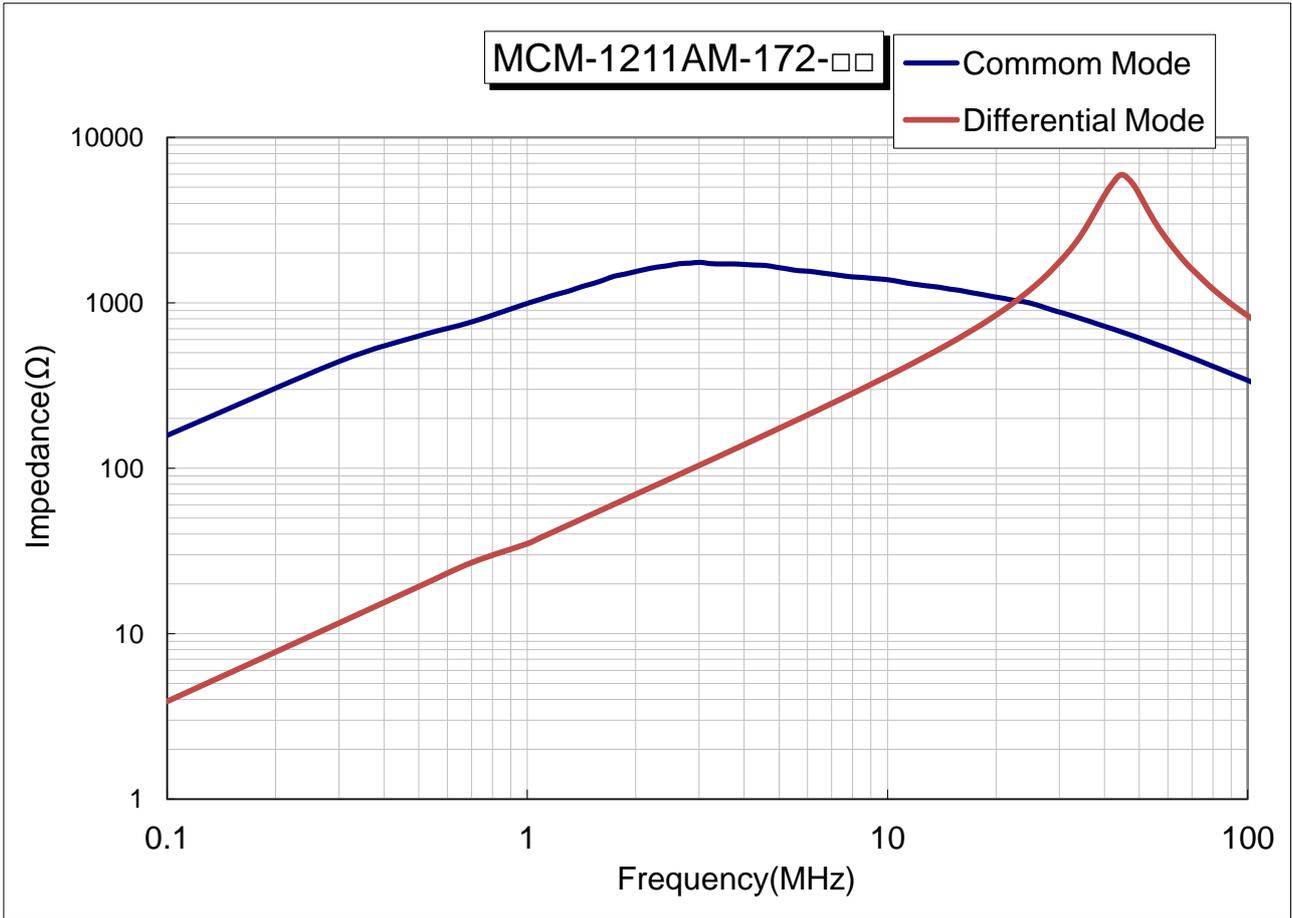
**(6)-4 QUANTITY**

500pcs/Reel

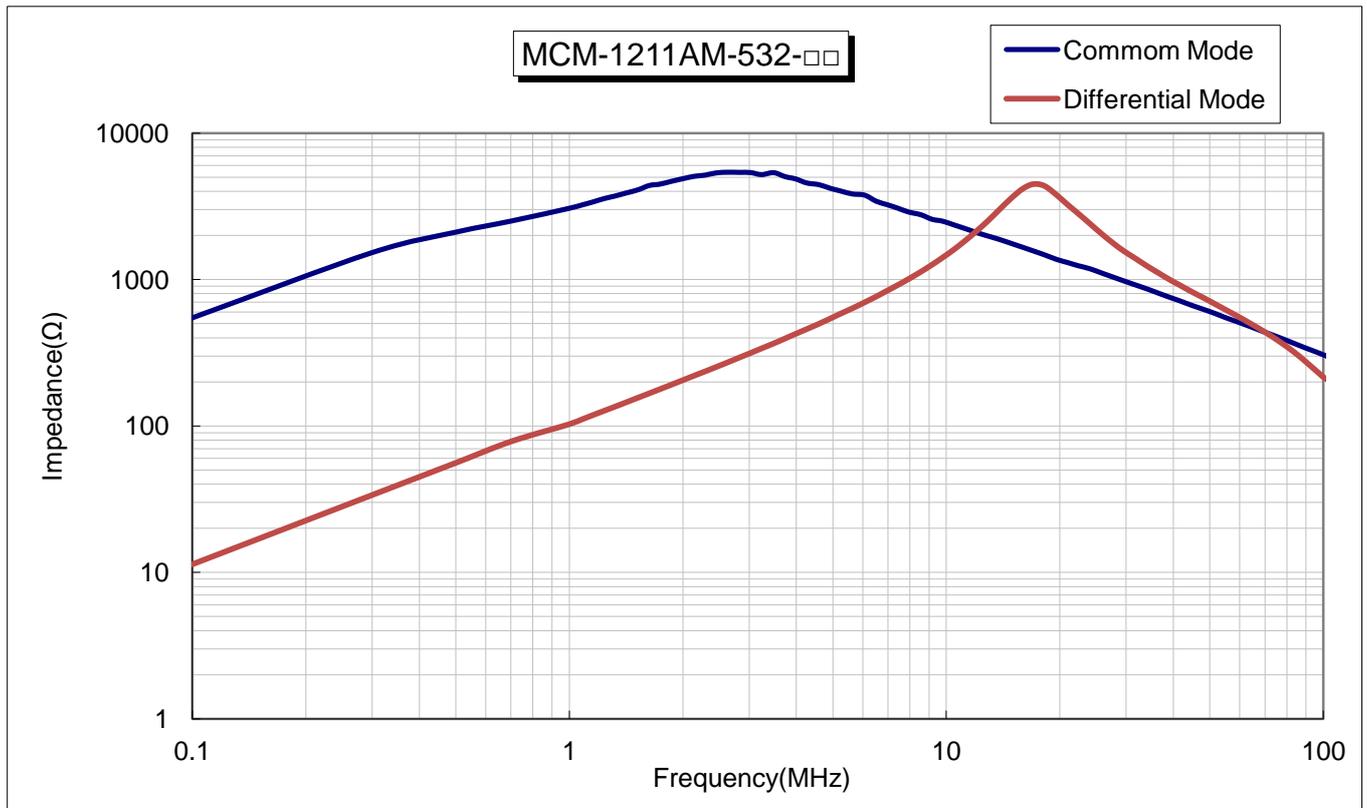
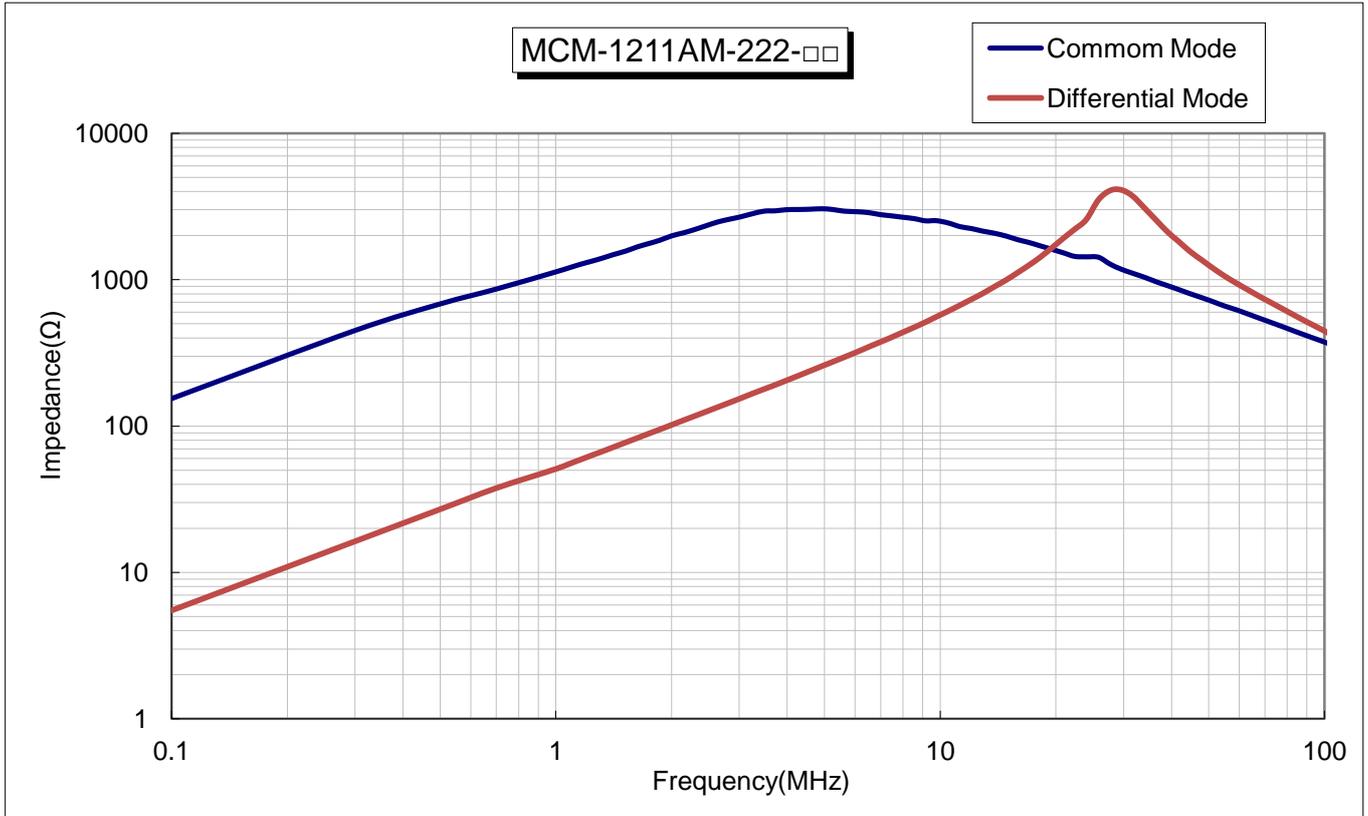
The products are packaged so that no damage will be sustained.

Please note that the contents may change without any prior notice due to reasons such as upgrading.

# TYPICAL ELECTRICAL CHARACTERISTICS



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